SPDT SECTION	SECTION 2
	Pages
SLIM LINE series	

SLIM LINE series	1 9853
SMT Power Micro-SPDT with 10 GHz capabilities: R596 Series	2-2 to 2-11
RAMSES Series	
SPDT up to 50 GHz: R570 Series (miniature models)	2-12 to 2-15
SPDT up to 50 GHz: R572 Series (miniature: Low Consumption & Reduced Size models)	2-16 to 2-19
SPDT up to 18 GHz: R570 Series (Standard models)	2-20 to 2-23
Electrical Schematics	
R570 & R572 Series	2-24 to 2-27
PLATINUM Series	
High Performance SPDT up to 26.5 GHz: R595 Series	2-28 to 2-33
OPTIONAL FEATURES	2-34

SPDT PRODUCTS SELECTION GUIDE

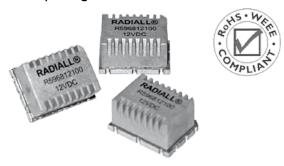
Quick access to the right page:

					Frequency	/			
Connector	DC - 2.5	DC - 3	DC - 6	DC - 8	DC - 12.4	DC - 18	DC - 26.5	DC - 40	DC - 50
DIN1.6/5.6	2-12 / 2-16								
SMB/SMC		2-12 / 2-16							
Mini SMB		2-12 / 2-16							
BNC		2-20							
QMA			2-12 / 2-16						
SMT			2-20						
PC Board				2-12					
N					2-20				
TNC						2-20			
SMA							2-12 / 2-16		
SMA2.9								2-12 / 2-16	
2.4mm									2-12 / 2-16

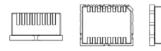
For more detailed technical information please consult Radiall customer support.

SURFACE MOUNT TECHNOLOGY

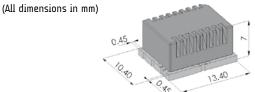
Patent pending



ACTUAL SIZE



TYPICAL OUTLINE DRAWING



An innovative and original «micro-mechanical» design allows the R596 SMT micro-relay to bring together the excellent reliability, RF and repeatability characteristics of coaxial switches with the miniature size and low cost implementation of surface mount components.

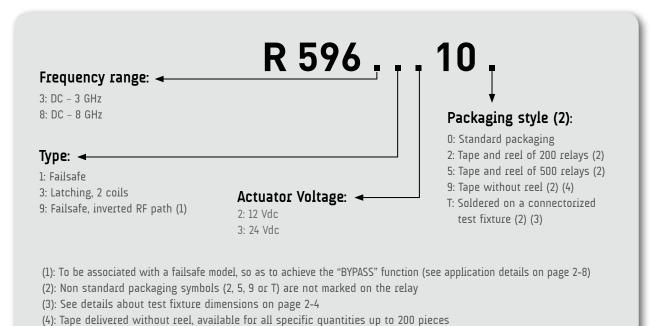
Very low return loss and insertion loss allow this relay to be used in power applications, as well as in typical SMT relay applications such as RF attenuators, RF matrices, spectrum analysers, and telecommunications.

Failsafe models are offered in two RF configurations (direct and inverted): The association of these two products on the same PC board enables the product to perform the «BYPASS» function. (For Bypass mounting, further information is available on page 2-8).

Example of P/N:

R596813100 is a SPDT SMT 8 GHz, 24 Vdc, failsafe, standard packaging.

PART NUMBER SELECTION



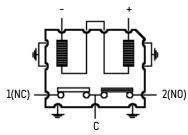
SMT POWER MICRO SPDT with 10 GHz capabilities

GENERAL SPECIFICATIONS

Operating mode			Failsafe (types 1 and 9)		Latching	g (type 3)	
Nominal operating (across temperatur			12 (10.2 to 13)	24 (20.5 to 30)	12 (10.2 to 13)	24 (20.5 to 30)	
Coil resistance at 2	3°C (+/-10%)	Ohms	330	1130	205	865	
Operating current a	at 23°C	mΑ	36	25	58	32	
RF and command po	orts		½ hole gold plated, Infrared reflow, forced air oven or hand soldering (Compatible with "lead free" soldering processes)				
Switching time at	Making contacts		Max 4ms (typica	l 1.8ms), including	contact bounce	time	
nominal voltage	Breaking contacts		Max 1ms (typical	l 0.5ms)			
Life	- Cold switching (max 120 cy	cles/min)		2 million	n cycles		
riie	Life - Hot switching (max 20 cycles/min)			500.000 cycles (1W, impedance 50Ω, V.S.W.R. < 1.25)			
Insulation	Insulation		Dielectric test voltage 300 Vrms			Vrms	
			Insulation resistance at 500Vdc > 100 M0hms				
Environmental prot	ection		"LEAD FREE" construction – Waterproof (acc. To IEC 60529 / IP67)				
Mass			< 2g				
Operating temperat	ure range	°C	Fails	safe	Latc	hing	
(with no icing nor o	condensation)	L .	-25 to +85 (5) -40 to +85			+85	
Storage temperatur	Storage temperature range °C		-55 to +85				
Cina vibration (MII	Cincaributation (MIL CTD 202 Mark at 2070)		- Condition D: 10-2000 Hz, 20g operating				
ZILIE AINTATION (LIIF	Sine vibration (MIL STD 202, Method 204D)		- Condition G: 10-2000 Hz, 30g non operating			ng	
Dandom vibration (Random vibration (MIL STD 202, Method 214A, Profile I)		- Condition F: 50	0-2000 Hz, 20.71g	operating		
KANDON ANTALION (- Condition H: 50	0-2000 Hz, 29.28g	non operati	ng	
Shocks (According t	o MIL STD 202, Method 213B, 0	Cond. C)	100g / 6 ms, ½	sine	operating		

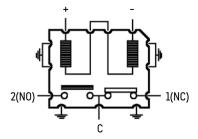
^{(5):} Failsafe models may be used down to -40°C, but if coil remains permanently supplied at nominal voltage, the holding current value must be reduced by 45% to 55% so as to avoid internal condensation. (for more details, see RADIALL application note AN-R596-51 on page 2-10).

PIN IDENTIFICATION (TOP VIEW)



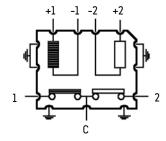
Failsafe model (type 1)

Voltage	RF continuity
De-energized	C <> 1(NC)
Energized	C <> 2(NO)



Inverted failsafe model for bypass applications (type 9)

Voltage	RF continuity
De-energized	C <> 1(NC)
Energized	C <> 2(NO)



Latching model (type 3)

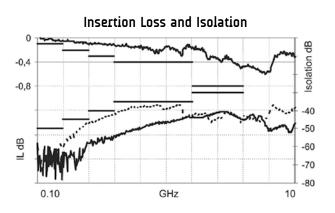
Voltage	RF continuity
-l +l	C <> 1
-2 +2	C <> 2

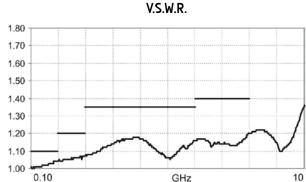


RF PERFORMANCES (S parameters available on request)

Frequency	Range GHz	V.S.W.R. (max)	Insertion Loss (max) dB	Isolation switch alone	(min) dB switch + board layout (6)		power W nge 2-5) hot switching	Third order Inter modulation	Impedance Ohms
	DC - 1	1.10	0.10	50	50	400	50		
DC - 3	1 - 2	1.20	0.20	45	40	280	50	-120 dBc	
	2 - 3	1.35	0.30	40	30	175	40	typical (2 carriers	50
DC - 8	3 - 6	1.35	0.40	35	30	50	25	20W)	
	6 - 8	1.40	0.80	30	30	35	5		

TYPICAL RF PERFORMANCE

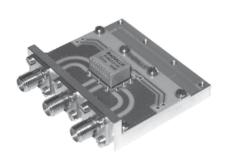


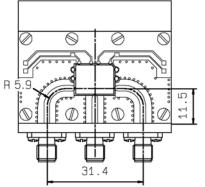


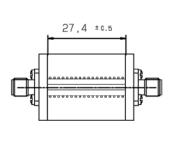
(6): taking account of the reduction of isolation due to coupling between PCB microstrip lines (see isolation dotted curve above and measurement method below)

MEASUREMENT METHOD

Relay soldered on text fixture (7)







Calibration board

Inputs/Outputs of the calibration board and test fixture are equipped with SMA type receptacle connectors, RADIALL part number R125 510 000. The length of the RF tracks are the same on the calibration board and the test fixture circuits. The insertion loss of the relay itself is calculated by subtracting the insertion loss of the "calibration board" to the insertion loss of the "relay welded on the test fixture".

(7): Relay soldered on Test Fixture available. To order, please use the suffix « T » (part number R596 - - - - - T), as explained in page 2-2.



SMT POWER MICRO SPDT with 10 GHz capabilities

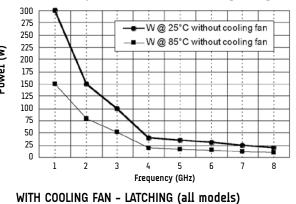
RF POWER RATING For COLD SWITCHING USE

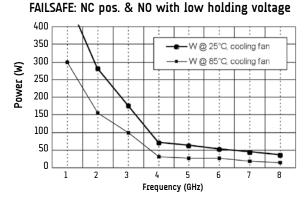
(Impedance 50 Ohms, V.S.W.R. < 1.25)

Power level depends on environmental conditions:

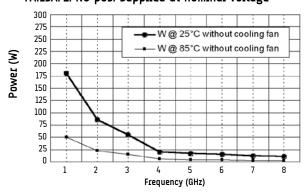
- R596 series have been designed to be used without a cooling fan even for high power applications. However, the power capability may be still improved by using the appropriate cooling fan.
- For failsafe models used with coil permanently supplied (N/O position), the same power level as latching models may be applied: see on application note N° AN-R596-51 on page 2-10, how to implement a "low holding current" function on your PC board, so as to avoid internal overheating and increase the RF power level.

NO COOLING FAN - LATCHING (all models) FAILSAFE: NC pos. & NO with low holding voltage

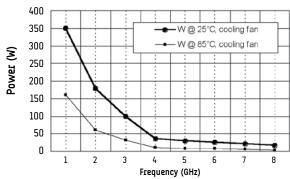




NO COOLING FAN FAILSAFE: NO pos. Supplied at nominal voltage



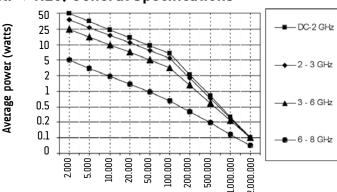
WITH COOLING FAN FAILSAFE: NO pos. Supplied at nominal voltage



LIFE DERATING CURVE FOR HOT SWITCHING USE

(Impedance 50 Ohms, V.S.W.R. < 1.25) General Specifications

Impedance 50Ω V.S.W.R. < 1.25 max switching frequency: 30 cycles per mn



To download technical data sheets, visit www.radiall.com & enter the part number in the Search box. For more detailed technical information please consult Radiall customer support.

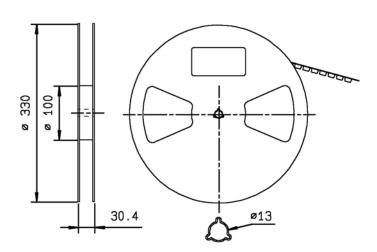
RADIALL®
The next conneXion

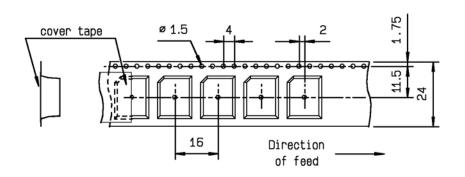
MICRO SPDT RELAYS

RELAY PACKAGING

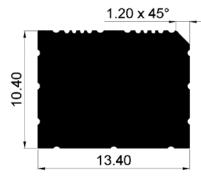
ACCORDING TO IEC 286-3 STANDARD

MATERIALS: Reel: polyester Carrier tape: antistatic PETG (polyester) Cover tape: polyester

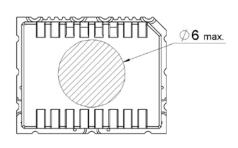




Video shadow of the relay



Aspiration Aera



SMT POWER MICRO SPDT with 10 GHz capabilities

PC BOARD MOUNTING

Board layout

13.8 10,2 62 through holes Ø0.6 1.5 mm spaced unless 0,4 2,4 otherwise specified DXF or GERBER format file available upon request (8) 92 ູດ R 1.22 R 0.64 8 3x 5,83 8 e, ĕ 61 0 0 0,2 6x0,7 Ю 6x0,2 0,4mm (holes position) 10.1 13,8

Subtrate Types

Recommended substrates are ROGERS RO4003 or ARLON 25N,

- Mounting face: Thickness 0.813 mm Cu double side 17.5 µm. Width of track 1.83 mm Others substrates: R04350, thickness 0.813 mm Cu double side 17.5µm. Width of track 1.80 mm 25FR, thickness 0.813 mm Cu double side 17.5µm. Width of track 1.76 mm
- Opposite face: Plating all over the face.

Total thickness of the tracks (copper over thickness + plating): 40µm.

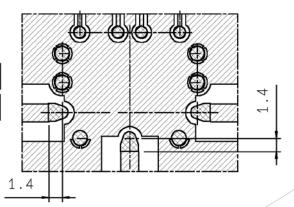
Other substrates may be used (for instance standard FR4), if provided with adequate modification of the tracks width.

Relay soldering pattern

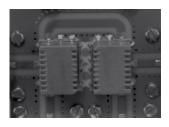
DXF format file available upon request (8)

(8): Please visit our customer support and / or contact us by e-mail.

Pattern Area for solder paste



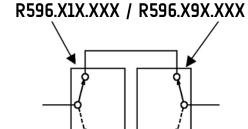
BYPASS APPLICATION: FAILSAFE MICRO-RELAY TYPICAL IMPLANTATION

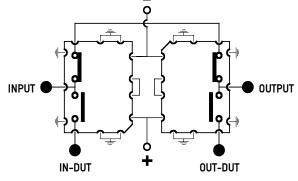


ACTUAL SIZE

SPDT relays (Single Pole Double Throw) can be used to achieve a Bypass switch function. For SMT applications, R596 series, relays are available in two failsafe versions, standard and inverted, to provide symmetric RF ports implantation possibility. The "side by side" implementation of these two versions on a PCB effectively produces the «BYPASS» function: the package size is reduced and interconnecting tracks are shortened. As required to protect the receiver for transmit/receive applications, and depending on the distance between the two relays, this configuration can achieve high isolation levels, up to 80 dB @1GHz, 70 dB @ 2 GHz, and 60 dB @ 6GHz.

BYPASS TYPICAL IMPLANTATION & PIN IDENTIFICATION (TOP VIEW)

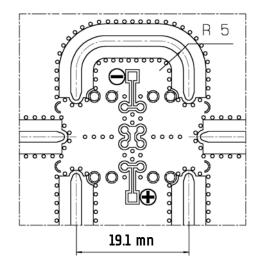




Voltage	RF continuity
De-energized	INPUT <> OUTPUT (direct line)
Energized	INPUT <> IN-DUT / OUT-DUT <> OUTPUT

BYPASS PC BOARD MOUNTING

Example of Board layout for BYPASS application.



(See detailed board layout on page 2-7)



SMT POWER MICRO SPDT with 10 GHz capabilities

RECOMMENDED SOLDERING PROCEDURE

A-Soldering procedure using automatic pick and place equipment

1-Solder paste:

R596 series are « Lead Free », and Lead Free Sn-Ag3.5-Cu0.7 solder cream may be used as well as standard Sn63-Pb35-Ag2. RADIALL recommends using a « no clean - low residue » solder cream (5% solid residue of flux quantity) that will permit the elimination of the cleaning operation step after soldering. Note: Due to the gold plating of the switch PCB interface, it is important to use a paste made with silver. This will help in avoiding formation of intermetallics as part of the solder joint.

2-Solder paste deposition:

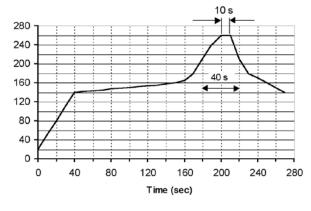
Solder cream may be applied on the board with screen printing or dispenser technologies. For either method, the solder paste must be coated to appropriate thickness and shapes to achieve good solder wetting. Please optically verify that the edges of the zone are clean and without contaminates, and that the PCB zoned areas have not oxydated. The design of the mounting pads and the stenciling area are given on page 2-7, for a thickness of the silk-screen printing of 0.15 mm (0.006 °).

3-Placement of the component:

For small lightweight components such as chip components, a self-alignment effect can be expected if small placement errors exist. However, this effect is not as expected for relays components and they require a accurate positioning on their soldering pads, typically +/- 0.1mm (+/-0.004"). Place the relay onto the PCB with automatic pick and place equipment. Various types of suction can be used. RADIALL does not recommend using adhesive agents on the component or on the PCB.

4-Soldering: infra-red process:

Please follow the RADIALL recommended temperature profile for infra-red reflow or forced air convection:



Higher temperature (> 260° C) and longer process duration would damage permanently the switches.

5-Cleaning procedure:

On miniature relays, high frequency cleaning may cause the contacts to stick. If cleaning is needed, please avoid ultrasonic cleaning and use alcohol based cleaning solutions.



In-line cleaning process, spraying, immersion, especially under temperature, may cause a risk of degradation of internal contacts.

6-Quality check:

Verify by visual inspection that the component is centered on the mounting pads. Solder joints: verify by visual inspection that the formation of meniscus on the pads are proper, and have a capilarity amount upper the third of the height.

B-Soldering procedure by manual operation

1-Solder paste and flux deposition:

Refer to procedure A - 1

Deposite a thin layer of flux on mounting zone. Allow the flux to evaporate a few seconds before applying the solder paste, in order to avoid dilution of the paste.

2-Solder paste deposition:

RADIALL recommends depositing a small amount of solder paste on the mounting zone area by syringe. Be careful, not to apply solder paste outside of the zone area.

3-Placement of the component:

During manipulation, avoid contaminating the lead surfaces by contact with fingers. Place the component on the mounting zone by pressing on the top of the relay lid.

4-Hand soldering:

Iron wattage 30 to 60 W. Tip temperature 280 to 300°C for max. 5 seconds To keep good RF characteristics above 3GHz, it is important to solder RF ports first, and apply pressure on the relay lid during all the soldering stage, so as to reduce the air gap between the PC board and the relay.

5-Cleaning procedure:

Refer to procedure A - 5.

6-Quality check:

Verify by visual inspection that component is centred on the mounting pads.

Solder joints: verify by visual inspection that the formation of meniscus on the RF pads are proper, and have a capillarity amount higher than one third of the height.



SMT POWER MICRO SPDT with 10 GHz capabilities

MICRO SPDT RELAYS

APPLICATION NOTE AN-R596-051

Subject: How to use failsafe R596 micro-relays over all the guaranteed temperature range, in icing or condensation environmental conditions.



RF and electrical characteristics are guaranteed on all failsafe R596 switches over their operating temperature range (-25°C to +85°C), and under "no icing nor condensation" conditions.

In extreme applications, with failsafe models used at low temperature, continuously in the N/O position (coil permanently supplied), N/C contact failures may occur, due to the high gradient of temperature between the coil (heated by the permanent power 500mW) and the RF paths.

N/O contact resistance remains satisfactory, but condensation deposits ice on the open contact N/C, and when power is cut, the N/C position is not correctly established.

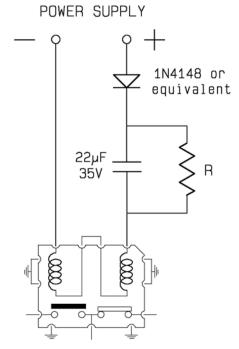
Failsafe models can be driven continuously energized from -40° C, if the coil is not permanently supplied at nominal voltage, to avoid heating and internal condensation: once the relay has switched, the operating voltage must be reduced by 50% + /-5%. This low holding voltage is possible on R596 series, as it is enough to maintain the switch in "energized" position (for instance 5.4V to 6.6V for a 12V model). Furthermore it allows the user to save energy, by combining the advantages of latching and failsafe models.

This "holding current" function can be achieved by the implementation of a simple electronic drive on the command PC Board (1 resistor, 1 diode and 1 capacitor), for 12V and 24V models. A typical circuit design is shown on the schematic below. A few milliseconds after switching, the current is divided by two, and the absorbed power is divided by four (i.e. 6V and 110mW for a 12V model).

To reduce the voltage by 50%, the value of resistance R must be equal to the total resistance of the switch coil:

- 12V models: 330 Ohms 1/4W

- 24V models: 1200 Ohms 1/4W



R596 FAILSAFE RELAY



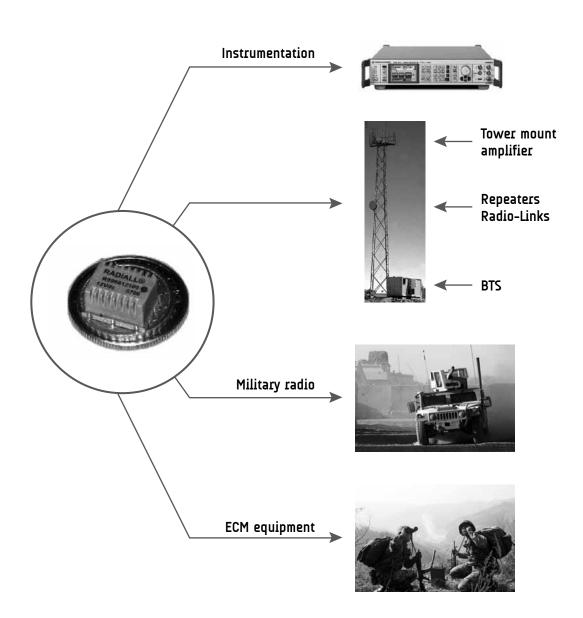
APPLICATIONS

EXAMPLE OF SMT APPLICATIONS

The SMT Series offers a large range of products which can be used in many applications such as:

- Tower mount amplifiers
- Instrumentation
- Military radios
- ECM equipment
- BTS
- Radio-Links
- Repeaters

These products offer the same RF Board and soldering process as all RF components but with a reduced weight and size. They are also specified for all market specifications.





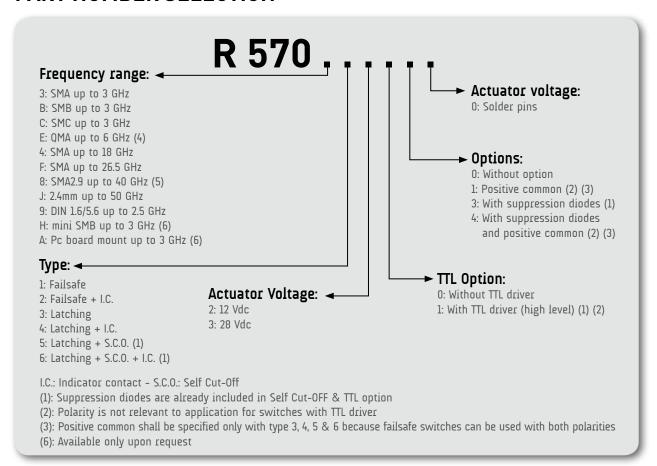
Radiall's RAMSES SPDT switches offer excellent reliability, high performance and operating frequencies from DC to 50 GHz. With RADIALL's RAMSES Concept (which provides for a life span of 10 million cycles) all options are available to respond to customer needs.

These relays are dedicated to all market applications including: Military, Instrumentation and Telecommunications.

Example of P/N:

R570413100 is a SPDT SMA 18 GHz, failsafe, 28 Vdc, with TTL driver, without option, solder pins.

PART NUMBER SELECTION



(4): The QLF tradermark (Quick Lock Formula®) standard applies to QMA and QN series and guaranties the full intermateability between suppliers using this tradermark. Using QLF certified connectors also guarantees the specified level of RF performances.

(5): Connector SMA2.9 is equivalent to "K connector®", registered trademark of Anritsu.





SPDT up to 50 GHz

Pc Board - SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

GENERAL SPECIFICATIONS

Operating mode	Failsafe Latching			hing			
Nominal operating voltage (across temperature range)		Vdc	12	28	12	28	
Monitial oberacting voltage (act	.uss temperature range)	VUL	(10.2 to 13)	(24 to 30)	(10.2 to 13)	(24 to 30)	
Coil resistance at 23°C (+/-10%	(o)	Ω	47.5	275	58	350	
Operating current at 23°C		mΑ	250	102	210	80	
Average power			See	Power Rating	g Chart page 1	l-16	
TI Input	High level		2.5 t	o 5.5 Volts	800µA max	5.5 Volts	
TTL Input	Low level		0 to	0.8 Volts	20µA max	0.8 Volts	
Indicator rating				1 W / 30 V	V / 100mA		
Switching time		ms	10				
	SMA - SMA2.9 - QMA		10 million cycles				
Life	DIN 1.6/5.6 - Pc Board			5 million cycles			
Піє	SMB - SMC - mini SMB		2.5 million cycles				
	2.4mm			2 millio	n cycles		
Connectors			SMA - SMA2.9 - QMA - DIN 1.6/5.6 - SMB - SMC				
Oblinication 5			Mini SMB - Pc Board - 2.4 mm				
Operating temperature range	DIN 1.6/5.6 - SMB - SMC - mini	SMB - 2.4mm	-25°C to +70°C				
operating temperature range	SMA - SMA2.9 - QMA - Pc Boar	d	-40°C to +85°C				
Storage temperature range DIN 1.6/5.6 - SMB - SMC - mini SMB - 2.4mm			-40°C to +85°C				
Storage temperature range SMA - SMA2.9 - QMA - Pc Board			-55°C to +85°C				
Vibration (MIL STD 202, Method	10-2000 Hz, 20g Operating			ating			
Shock (MIL STD 202, Method 213	3B, cond.C)		100g / 6m	ıs, ½ sine	Opera	ating	

RF PERFORMANCES

Connectors	Frequency Range GHz		V.S.W.R.	Insertion Loss	Isolation	Impedance
	' '		(max)	(max) dB	(min) dB	Ohms
DIN 1.6/5.6	DC - 2.5	DC - 1	1.20	0.20	80	
DIN 1.0/3.0	DC - 2.5	1 - 2.5	1.30	0.30	70	75
Mini CMD	DC - 3	DC - 1	1.20	0.20	80	/5
Mini SMB	DC - 3	1 - 3	1.30	0.30	70	
SMB - SMC	DC - 3	DC - 3	1.20	0.20	80	50
OMA	חר ר	DC - 3	1.20	0.20	80	50
QMA	DC - 6	3 - 6	1.30	0.30	70	50
		DC - 3	1.20	0.20	80	
	DC - 3	3 - 8	1.30	0.30	70	
SMA	DC - 18 DC - 26.5	8 - 12.4	1.40	0.40	60	50
		12.4 - 18	1.50	0.50	60	
		18 - 26.5	1.70	0.70	55	
		DC - 6	1.30	0.30	70	
		6 - 12.4	1.40	0.40	60	
SMA 2.9	DC - 40	12.4 - 18	1.50	0.50	60	50
		18 - 26.5	1.70	0.70	55	
		26.5 - 40	1.90	0.80	50	
PC Board	DC - 3	DC - 3	1.20	0.20	80	50
		DC - 6	1.30	0.30	70	
		6 - 12.4	1.40	0.40	60	
2/	DO 50	12.4 - 18	1.50	0.50	60	50
2.4mm	DC - 50	18 - 26.5	1.70	0.70	55	
		26.5 - 40	1.90	0.80	50	
		40 - 50	1.90	1.10	50	

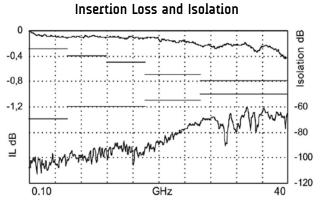
See page 2-14, 2-18 and 2-19 for typical RF performances

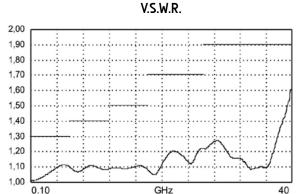


COAXIAL SPDT RELAYS

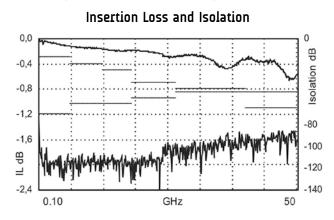
R570 AND R572 TYPICAL RF PERFORMANCES

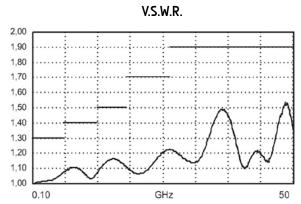
Example: SPDT SMA2.9 up to 40 GHz



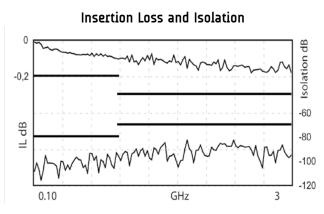


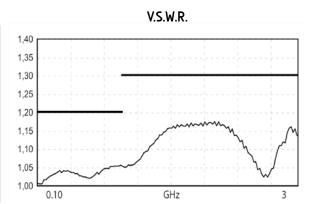
Example: SPDT 2.4mm up to 50 GHz





Example: SPDT mini SMB up to 3 GHz





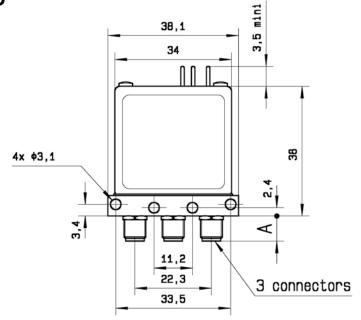
Note: see page 2-18 for other connectors.

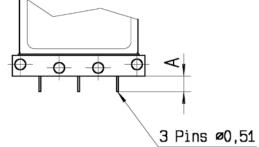
SPDT up to 50 GHz

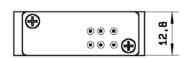
Pc Board - SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

TYPICAL OUTLINE DRAWING

Connectors	A max (mm)
SMA	7.4
SMA2.9 & 2.4mm	6.3
SMB - SMC	9.3
QMA	10.8
Mini SMB	7.5
DIN 1.6/5.6	11.5
Pc Board	4.5





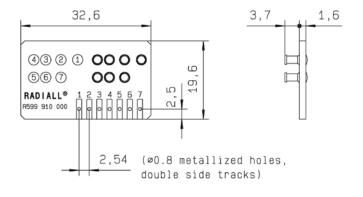


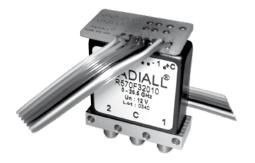
See page 2-27 for pin identification.

ACCESSORIES

A printed circuit board interface connector (ordered separately) has been designed for easy mounting on terminals.

For SPDT model R570 series => Radiall part number: **R599 910 000**



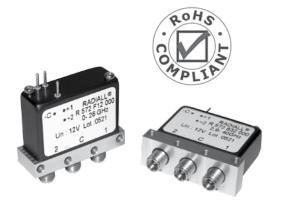




SPDT up to 50 GHz: Low Consumption & Reduced Size

SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

COAXIAL SPDT RELAYS



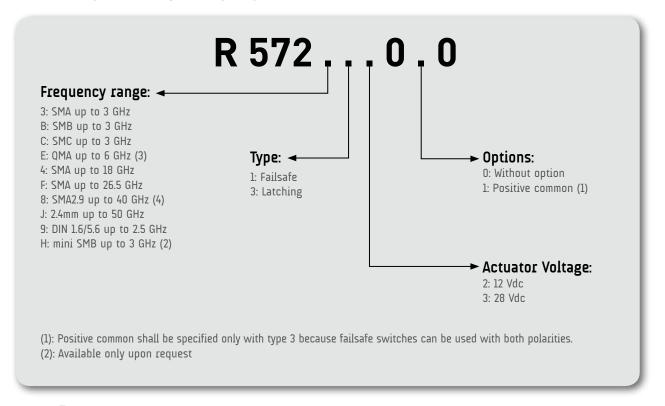
RADIALL'S RAMSES R572 SERIES are ideal for RF & Microwaves systems where low current consumption, reduced size, high performance and high reliability are required. Other options are also available as shown on this page.

These relays are perfect for all market applications including: Industrial, Instrumentation, Defense and Telecommunications as well.

Example of P/N:

R572432010 is a SPDT SMA 18 GHz, latching, 12 Vdc, positive common, solder pins.

PART NUMBER SELECTION





- (3): The QLF tradermark (Quick Lock Formula®) standard applies to QMA and QN series and guaranties the full intermateability between suppliers using this tradermark. Using QLF certified connectors also guarantees the specified level of RF performances
- (4): Connector SMA2.9 is equivalent to "K connector®", registered trademark of Anritsu.



SPDT up to 50 GHz: Low Consumption & Reduced Size SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

GENERAL SPECIFICATIONS

Operating mode			Failsafe Latching				
Nominal operating	g voltage	Vdc	12	28	12	28	
(across temperati	ure range)	Vuc	(10.2 to 13)	(24 to 30)	(10.2 to 13)	(24 to 30)	
Coil resistance at	: 23°C (+/-10%)	Ω	75	450	58	350	
Operating current	at 23°C	mA	160	62	210	80	
Average power				See Power Rating	g Chart page 1-16		
Switching time		ms		1	0		
Life	Life			2.5 million cycles (2 million cycles for connectors 2.4 mm)			
Connectors			SMA - SMA2.9 - QMA - DIN 1.6/5.6 - SMB - SMC - 2.4 mm				
Operating	DIN 1.6/5.6 - SMB - SMC - mini SME	3 - 2.4mm	-25°C to +70°C				
temperature range	SMA - SMA2.9 - QMA - Pc Board		-40°C to +85°C				
Storage	5			-40°C to +85°C			
range SMA - SMA2.9 - QMA - Pc Board			-55°C to +85°C				
Vibration (MIL STD 202, Method 204D, cond.C)		10-2000 Hz, 20g Operating					
Shock (MIL STD 20	02, Method 213B, cond.G)		50g, 11m	s, ½ sine	e Operating		

RF PERFORMANCES

Connectors	Frequency Range GHz		V.S.W.R. (max)	Insertion Loss (max) dB	Isolation (min) dB	Impedance Ohms	
DIN 1.6/5.6	DC - 2.5	DC - 1	1.20	0.20	80		
DIN 1.0/5.0	DC - 2.5	1 - 2.5	1.30	0.30	70	75	
Mini SMB	DC - 3	DC - 1	1.20	0.20	80	/3	
סוגוכ זווזוו.ו	DC - 3	1 - 3	1.30	0.30	70		
SMB - SMC	DC - 3	DC - 3	1.20	0.20	80	50	
OMA	חר ר	DC - 3	1.20	0.20	80	го	
QMA	DC - 6	3 - 6	1.30	0.30	70	50	
	DC - 3 DC - 18 DC - 26.5	DC - 3	1.20	0.20	80		
		3 - 8	1.30	0.30	70		
SMA		8 - 12.4	1.40	0.40	60	50	
		12.4 - 18	1.50	0.50	60		
		18 - 26.5	1.70	0.70	55		
	DC - 40	DC - 6	1.30	0.30	70		
		6 - 12.4	1.40	0.40	60		
SMA2.9		12.4 - 18	1.50	0.50	60	50	
		18 - 26.5	1.70	0.70	55		
		26.5 - 40	1.90	0.80	50		
	·	DC - 6	1.30	0.30	70		
		6 - 12.4	1.40	0.40	60		
2.4mm	DC - 50	12.4 - 18	1.50	0.50	60	En	
4. 4 111111	DC - 20	18 - 26.5	1.70	0.70	55	50	
		26.5 - 40	1.90	0.80	50		
		40 - 50	1.90	1.10	50		



SPDT up to 50 GHz: Low Consumption & Reduced Size SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

COAXIAL SPDT RELAYS

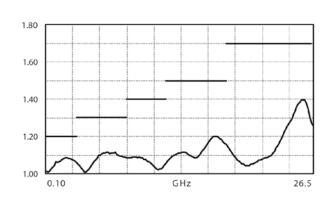
R570 AND R572 TYPICAL RF PERFORMANCES

Example: SPDT SMA up to 26.5 GHz

Insertion Loss and Isolation

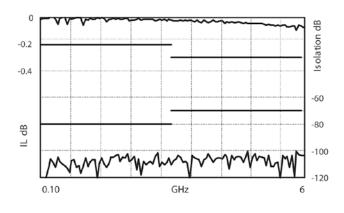
Isolation dB -0.4 -0.8 -60 -80 용 -100 -120 GHz 26.5

V.S.W.R.

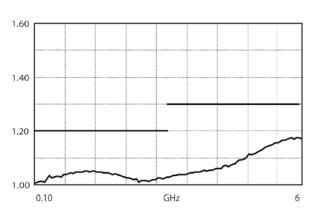


Example: SPDT QMA up to 6 GHz

Insertion Loss and Isolation



V.S.W.R.



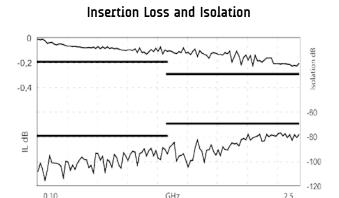
Note: see page 2-14 for other connectors.

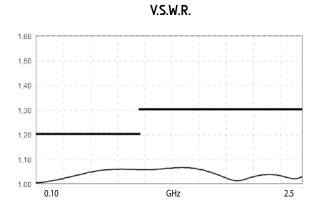


SPDT up to 50 GHz: Low Consumption & Reduced Size SMA - SMA2.9 - 2.4mm - QMA - SMC - SMB - mini SMB - DIN 1.6/5.6

R570 AND R572 TYPICAL RF PERFORMANCES

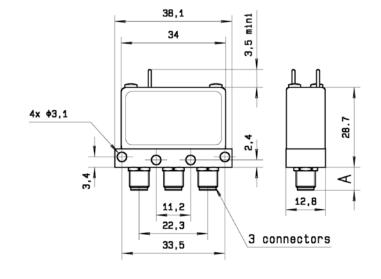
Example: SPDT DIN 1.6/5.6 up to 2.5 GHz

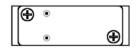




TYPICAL OUTLINE DRAWING

Connectors	A max (mm)
SMA	7.4
SMA2.9 & 2.4mm	6.3
SMB - SMC	9.3
QMA	10.8
Mini SMB	7.5
DIN 1.6/5.6	11.5





See page 2-27 for pin identification



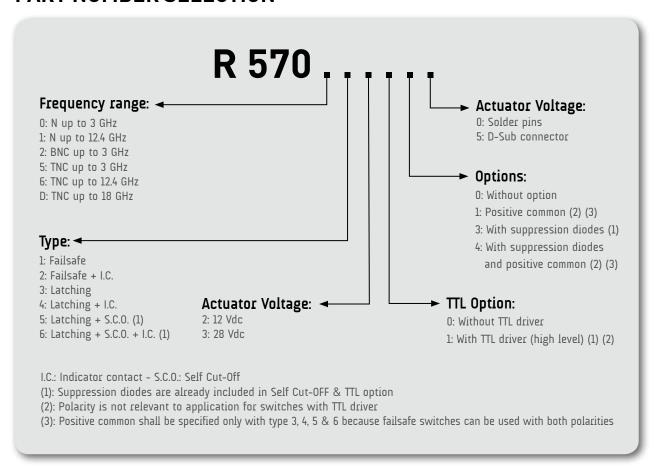
RADIALL'S RAMSES SPDT N, BNC & TNC switches are designed for high performance in RF & Microwave systems up to 18 GHz. With RADIALL'S RAMSES concept (modular concept) a full range of configurations are available. They are commonly used for applications where high power handling capability is required.

These relays are dedicated to all market applications including: Defense, Instrumentation and Telecommunications.

Example of P/N:

R570113035 is a SPDT N 12.4 GHz, failsafe, 28 Vdc, with supression diodes, without option, D-Sub connector.

PART NUMBER SELECTION





SPDT UP TO 18 GHz N - TNC - BNC

GENERAL SPECIFICATIONS

Operating mode			Fails	Failsafe Latching			
Nominal operating volta	ge	Vdc	12	28	12	28	
(across temperature range)		vuc	(10.2 to 13)	(24 to 30)	(10.2 to 13)	(24 to 30)	
Coil resistance at 23°C ((+/-10%)	Ω	47.5	275	38	225	
Operating current at 23°	°C	mΑ	250	102	320	125	
Average power				See Power Rating	Chart page 1-16		
High level			2.2 to 5.5 Volts 800μA max 5.5 Volts			5 Volts	
TTL input	Low level		O to 0.8 Volts 20μA max 0.8 Volts			3 Volts	
Switching time		ms	15				
Life			2.5 million cycles				
Connectors				N - TNC - BNC			
Actuator terminals			Solders pins or 9 pin D-Sub connector				
Operating temperature i	ange		-40°C to +85°C				
Storage temperatur erange			-55°C to +85°C				
Vibration (MIL STD 202, Method 204D, cond.D)			10-2000	10-2000 Hz, 20g Operating			
Shock (MIL STD 202, Met	hod 213B, cond.C)		100g / 6 m	ns, ½ sine	Non operating		

RF PERFORMANCES

Connectors	Frequency Range GHz		V.S.W.R. (max)	Insertion Loss (max) dB	Isolation (min) dB	Impedance Ohms	
		DC - 1	1.15	0.15	85		
		1 - 2	1.20	0.20	80	0hms 50	
N / TNC	DC - 3 DC - 12.4	2 - 3	1.25	0.25	75		
	50 12.1	3 - 8	1.35	0.35	70		
		8 - 12.4	1.50	0.50	60		
		DC - 6	1.30	0.30	70		
TNC 18GHz	DC - 18	6 - 12.4	1.50	0.50	60	50	
		12.4 - 18	1.60	0.70	60		
		DC - 1	1.15	0.15	85		
BNC	DC - 3	1 - 2	1.20	0.20	80	50	
		2 - 3	1.25	0.25	75		

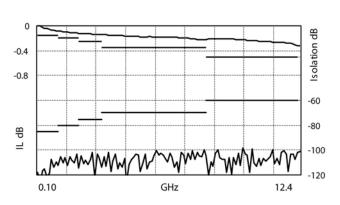
See page 2-22 for typical RF performances



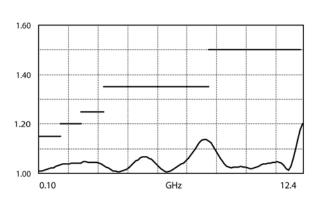
R570 TYPICAL RF PERFORMANCES

Example: SPDT N and TNC up to 12.4 GHz

Insertion Loss and Isolation

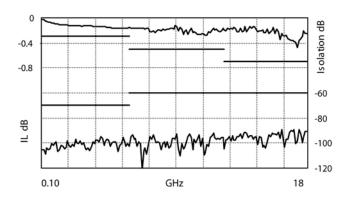


V.S.W.R.

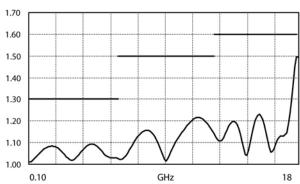


Example: SPDT TNC up to 18 GHz

Insertion Loss and Isolation



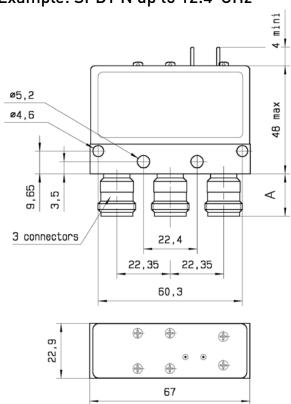
V.S.W.R.

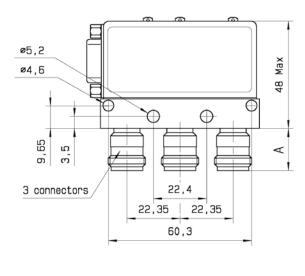


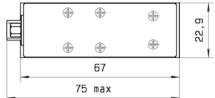
SPDT UP TO 18 GHz N - TNC - BNC

TYPICAL OUTLINE DRAWING

Example: SPDT N up to 12.4 GHz







See page 2-27 for pin allocation

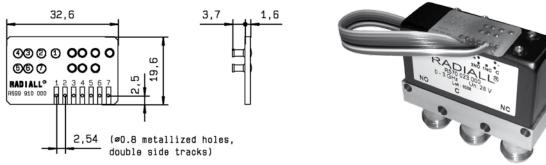
See page 2-27 for D-Sub pin allocation

Connectors	N	TNC	BNC
A max (mm)	17.7	11.3	11.3

ACCESSORIES

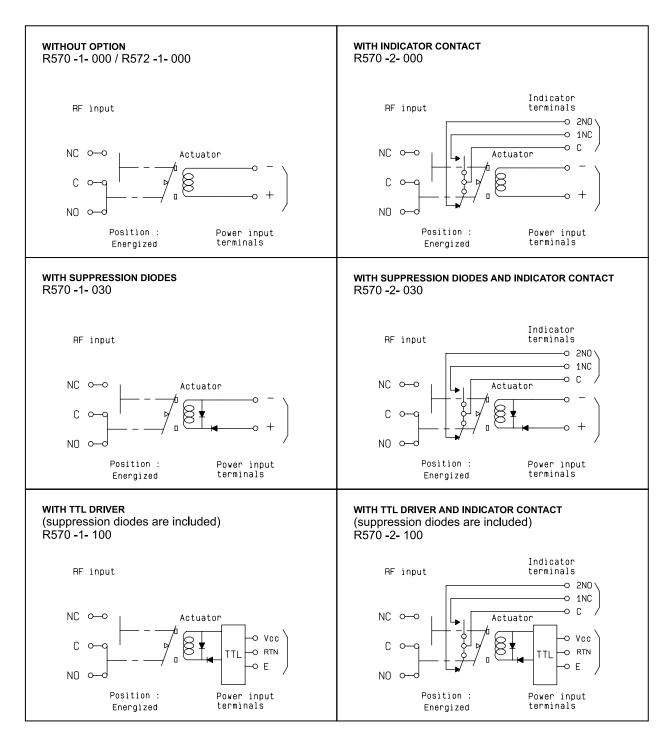
A printed circuit board interface connector (ordered separately) has been designed for easy mounting on terminals.

For SPDT model R570 series => Radiall part number: **R599 910 000**



To download technical data sheets, visit www.radiall.com & enter the part number in the Search box. For more detailed technical information please consult Radiall customer support.

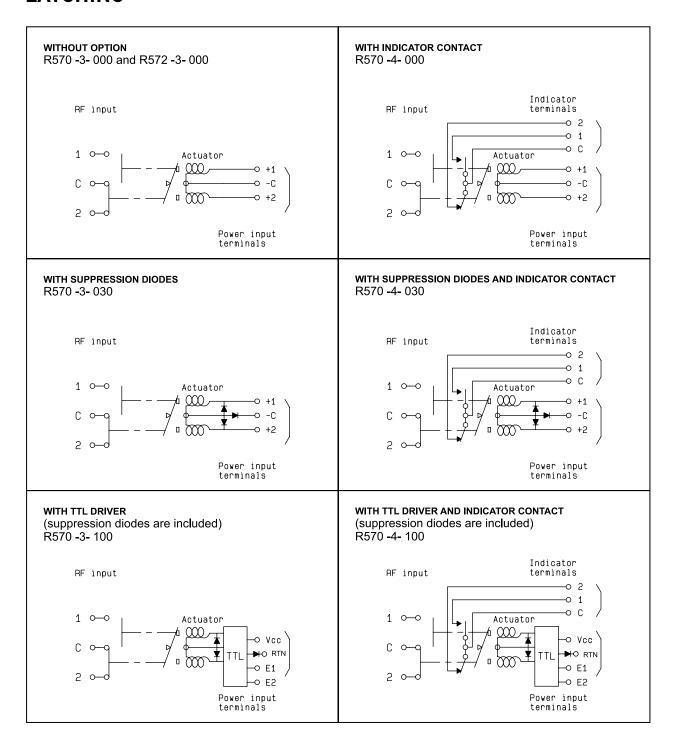
RADIALL® The next conneXion





COAXIAL SPDT - Electrical Schematics R570/R572 Series

LATCHING

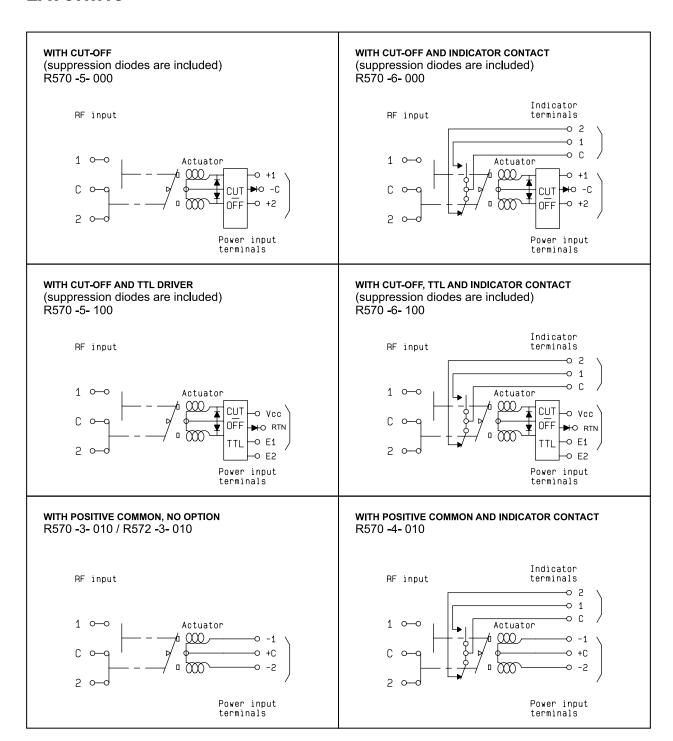




COAXIAL SPDT - Electrical Schematics R570/R572 Series

COAXIAL SPDT RELAYS

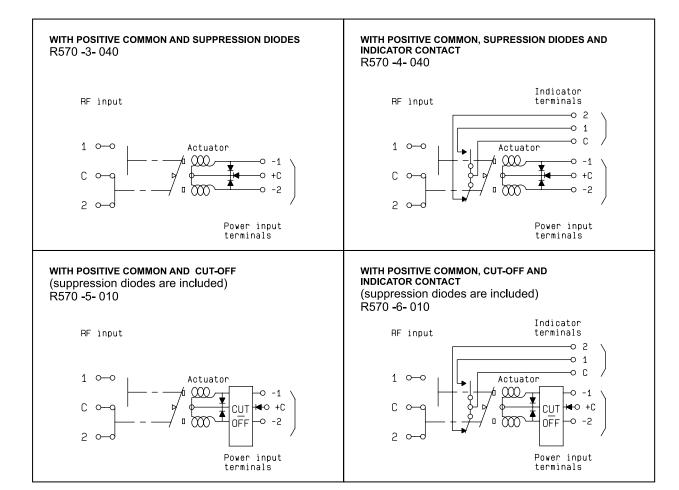
LATCHING





COAXIAL SPDT - Electrical Schematics R570/R572 Series

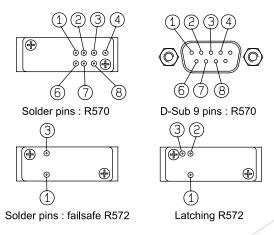
LATCHING



PIN IDENTIFICATION

Type				PIN			
Туре	1	2	3	4	6	7	8
Failsafe	+		-				
Failsafe + I.C.	+		-		2N0	1NC	С
Failsafe + TTL	E		RTN	VCC			
Failsafe + I.C. + TTL	E		RTN	VCC	2N0	1NC	С
Latching Latching + Cut-off	-2 or +2	-1 or +1	+C or -C				
Latching + I.C. Latching + I.C. + Cut-off	-2 or +2	-l or +l	+C or -C		2	1	С
Latching + TTL Latching + TTL + Cut-off	E2	E1	RTN	VCC			
Latching + TTL + I.C. Latching + TTL + I.C. + Cut-off	E2	E1	RTN	VCC	2	1	С

Bottom view



To download technical data sheets, visit www.radiall.com & enter the part number in the Search box. For more detailed technical information please consult Radiall customer support.

2-27

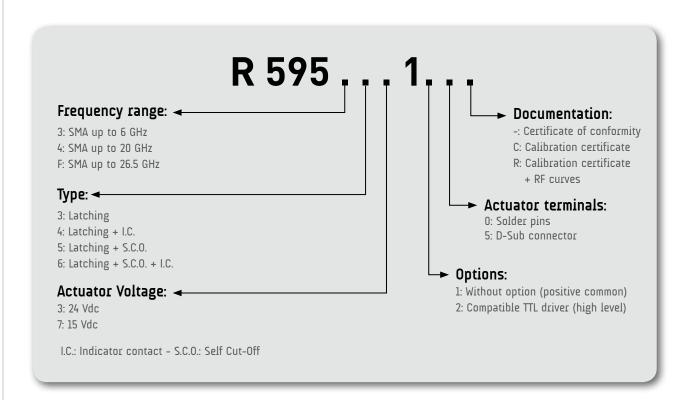


Radiall's PLATINUM SERIES switches are optimised to perform at a high level over an extended life span, with outstanding RF performances, and a guaranteed insertion loss repeatability of 0.03 dB over a life span of 10 million switching cycles. PLATINUM SERIES switches are perfect for automated test and measurement equipment, as well as signal monitoring devices.

Example of P/N:

R595443125 is a SPDT SMA 20 GHz, latching, 24Vdc, with TTL driver, Indicators, D-Sub connector.

PART NUMBER SELECTION





High performance SPDT up to 26.5 GHz SMA

GENERAL SPECIFICATIONS

Operating mode			Latching				
Nominal operating voltage (across temperature range)		24 (20 to 32)	15 (12 to 20)				
Coil resistance (+/-10%) Ω		350	120				
Operating current a	t 23°C	mΑ	68	125			
Average Power			RF Path Cold switching: see Power Rating Chart on page 2-33 Hot switching: 1 Watt CW				
TTL input	High level		3 to 7 Volts: 800µA max at 7 Volts				
TTE IIIput	Low level		0 to 0.8 Volts: 20μA max at 0.8 Volts				
Switching time	Switching time ms		15				
Life (min)			10 million cycles				
Connectors			SMA				
Actuator terminal			D-Sub 9 pin female Solder pins				
Weight (max)		g	6	0			

ENVIRONMENTAL SPECIFICATIONS

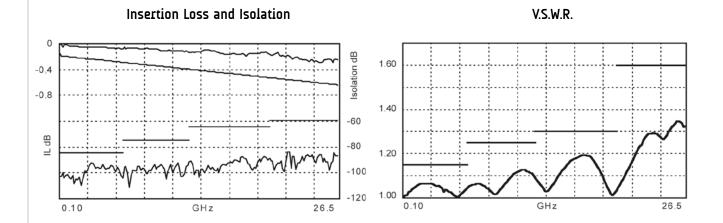
Operating temperature range	-25°C to +75°C
Storage temperature range	-55°C to +85°C
Temperature cycling (MIL STD 202F, Method 107D, Cond.A)	-55°C to +85°C (10 cycles)
Sine vibration operating (MIL STD 202, Method 204D, Cond.D)	20-2000 Hz, 20g
Random vibration operating	16.91g (rms) 50-2000 Hz 3min/axis
Shock operating (MIL STD 202, Method 213B, Cond.G)	50g / 11ms, sawtooth
Humidity operating	15 to 95% relative humidity
Humidity storage (MIL STD 202, Method 106E, Cond.E)	65°C, 95% RH, 10 days
Altitude operating	15.000 feet (4.600 meters)
Altitude storage (MIL STD 202, Method 105C, Cond.B)	50.000 feet (15.240 meters)



RF PERFORMANCES

Part Number		R59531	R59541		R595F1				
Frequency range	GHz	DC to 6	DC to 20		DC to 26.5				
Impedance Ω			50						
Insertion Loss (max)	dB	0.20 + (0.45 / 26.5) x frequency (GHz)							
			DC to 6 GHz	85	DC to 6 GHz	85			
Isolation (min)	dB	85	6 to 12.4 GHz	75	6 to 12.4 GHz	75			
	ub	03		65	12.4 to 20 GHz	65			
					20 to 26.5 GHz	60			
	·		DC to 6 GHz	1.15	DC to 6 GHz	1.15			
VCMD (may)		1.15	6 to 12.4 GHz	1.25	6 to 12.4 GHz	1.25			
V.S.W.R. (max)		1.15	12.4 to 18 GHz	1.30	12.4 to 18 GHz	1.30			
		18 to 20 GH		1.60	20 to 26.5 GHz	1.60			
Repeatability (up to 10 million cycles mesured at 25°C) dB			0.03 dB ma	ximun					

TYPICAL RF PERFORMANCES



High performance SPDT up to 26.5 GHz

SWITCH MODEL: NON TERMINATED SPDT SWITCH

The non terminated SPDT switch is a single pole double throw switch. This switch is "break before make".

RF SCHEMATIC DIAGRAM

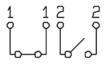
POSITION E1



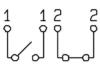
POSITION E2



POSITION INDICATOR



STATE "11"



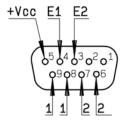
STATE "22"

Standard drive option "1" (Positive common):

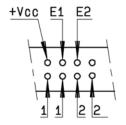
- Connect pin +Vcc to supply (+20 Vdc to +32 Vdc).
- · Select desired RF path by applying ground to the corresponding "close" pin (Ex: ground pin E1 to switch to position E1. RF path 1-2 closed and RF path 2-3 open).
- To open desired path and close the new RF path, connect ground to the corresponding "close" pin (Ex: ground pin E2 to open RF path 1-2 and close RF path 2-3).

TTL drive option "2"

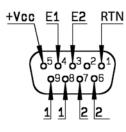
- Connect pin RTN to ground.
- Connect pin +Vcc to supply (+20 Vdc to +32 Vdc).
- · Select (close) desired RF path by applying TTL "High" to the corresponding "drive" pin (Ex: apply TTL "High" to pin E1 to switch to position E1. RF path 1-2 closed and RF path 2-3 open).
- To open desired path and close the new RF path, apply TTL "High" to the "drive" pin which corresponds to the desired RF path. (Ex: apply TTL "High" to pin E2 to open RF path 1-2 and close RF path 2-3).



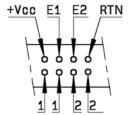
D-Sub connector



Solder pins



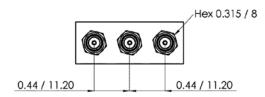
D-Sub connector



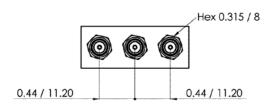
Solder pins

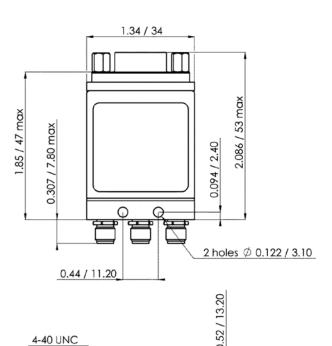
TYPICAL OUTLINE DRAWING

With D-Sub connector



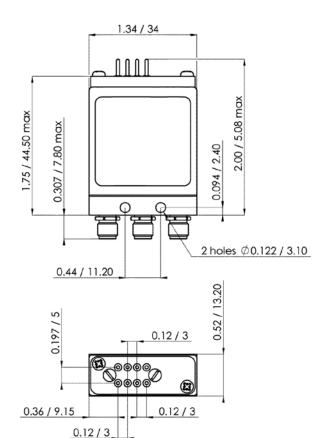
With solder pins





86868

0.984 / 25



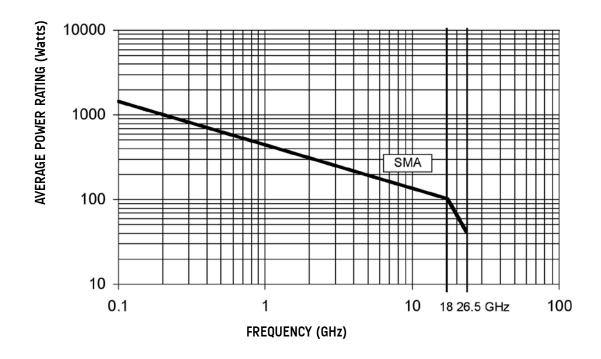
All dimensions are in inches/millimeters

High performance SPDT up to 26.5 GHz

RF POWER RATING CHART

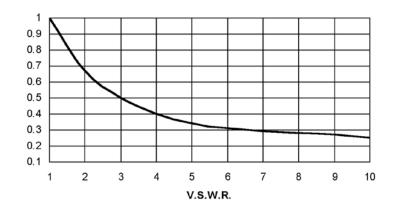
This graph is based on the following conditions:

- Ambient temperature: + 25°C
- Sea level
- V.S.W.R.: 1 and cold switching



DERATING FACTOR VERSUS VSWR

The average power input must be reduced for load V.S.W.R. above 1:1



Optional Features for SPDT

COAXIAL SPDT **RELAYS**

GENERAL

All miniature SPDT switches fitted with SMA, OMA. SMC. SMB or SMA2.9 connectors can be delivered with 34 mm narrow width RF body. Ask RADIALL for availability.



Examples of dedicated application options:



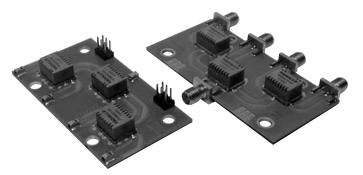
SMA SPDT with SINGLE input TTL driver. This option is available in latching configuration upon special request. Key advantages: Less wires, easier connection.



SPDT with HN coaxial connectors and MILC38999 circular connector for L band airbone applications.



SPDT models available for high power military applications (up to 100 watts CW from DC to 18 GHz).



A SP4T design up to 8 GHz with SMT relays mounted on a PCB fitted with UMP (Ultra Miniature Pressure) contact. Various switching configurations can be designed according to your specific requests.



A SMA SPDT with a specific RF body (with mounting leg) for easy mounting on front panel of switching matrix.

